

#### SURFACE MOUNT MICROPROCESSOR CRYSTAL

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### **SERIES H130B**

# FEATURES

- SMALL PACKAGE OF 5.0 x 3.2 x 1.0 mm
- EXCELLENT TOLERANCE AND STABILITY
- CUSTOM SPECIFICATIONS AVAILABLE

#### APPLICATIONS

- PAGERS
- CORDLESS TELEPHONES
- GPS
- BLUETOOTH



# SPECIFICATIONS

PARAMETER		VALUE	
FREQUENCY RANGE		8.000 MHz TO 150.000 MHz	
MODE OF OSCILLATION	FUNDAMENTAL	8.000 MHz TO 50.000 MHz	
MODE OF OSCILLATION	THIRD OVERTONE	40.000 MHz TO 150.000 MHz	
FREQUENCY TOLERANCE	ΔT 25°C	±50 PPM MAXIMUM	
L L COLINGT TOLLIVANCE AT 25 C		(±10, ±20, AND ±30 PPM AVAILABLE)	
EDECLIENCY STABILITY OF	/ED TEMPEDATI IDE	±50 PPM MAXIMUM	
FREQUENCY STABILITY OVER TEMPERATURE		(±10, ±20, AND ±30 PPM AVAILABLE)	
OPERATING TEMPERATURE RANGE		-20°C TO +70°C STANDARD	
		-40°C TO +85°C EXTENDED 1	
STORAGE TEMPERATURE RANGE		-40°C TO +90°C	
AGING		±3 PPM PER YEAR MAXIMUM	
LOAD CAPACITANCE		8 pF to 32 pF OR SERIES	
EQUIVALENT SERIES RESISTANCE		SEE TABLE 1	
SHUNT CAPACITANCE		5.0 pF MAXIMUM	
DRIVE LEVEL		100 μW TYP, 300 μW MAX	
SHOCK RESISTANCE		±5 PPM MAXIMUM 75 cm DROP TEST IN	
		3 AXES ONTO A HARD WOOD SURFACE	
REFLOW CONDITIONS		260°C ±5°C FOR 10s MAXIMUM	



<sup>&</sup>lt;sup>1</sup> NOTE: NOT ALL STABILITIES ARE AVAILABLE FOR ALL OPERATING TEMPERATURE RANGES. CONTACT FACTORY FOR AVAILABILITY.

TABLE 1				
FREQUENCY (MHz)	MODE	MAX ESR (OHMS)		
8.00 TO 9.99	FUND	85		
10.00 TO 11.99	FUND	60		
12.00 TO 15.99	FUND	35		
16.00 TO 19.99	FUND	25		
20.00 TO 50.00	FUND	20		
40.00 TO 59.99	3OT	70		
60.00 TO 150.00	3OT	60		

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#### **SERIES H130B**

#### PART NUMBERING SYSTEM

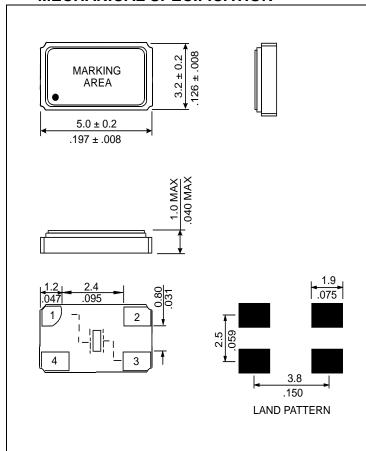
TYPE	-	FREQUENCY	-	LOAD CAPACITANCE	-	MODE	•	TOLERANCE/STABLITY (PPM/PPM)
H130B	-	IN MHz	1	8 TO 32 pF FOR PARALLEL S FOR SERIES	-	Blank FOR < 24.576 MHz F FOR ≥ 24.576 MHz 3OT THIRD OVERTONE		Blank FOR MAXIMUM PPMPPM Example: 1020, 2050

-	EXTENDED TEMPERATURE	-	TAPE & REEL
-	Blank FOR STANDARD EXT FOR EXTENDED	-	TR

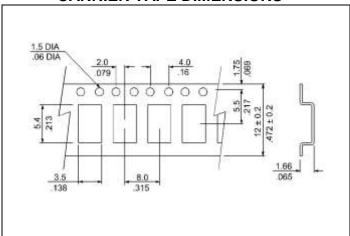
#### EXAMPLE: H130B-24.000-18-TR

Surface Mount Microprocessor Crystal, H130B package, 24.000 MHz, Fundamental mode, 18 pF load, ±50 ppm Tolerance, ±50 ppm Stability, from -20°C to +70°C, Tape and reel packaging

# MECHANICAL SPECIFICATION



# CARRIER TAPE DIMENSIONS



NOTE: REFER TO EIA-481 FOR NON-SPECIFIED DIMENSIONS

## PACKAGING

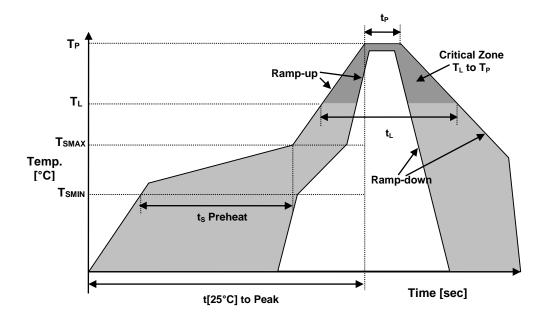
180 mm REEL DIAMETER
12 mm TAPE WIDTH, 8 mm PITCH
QUANTITY: 1000 PIECES PER REEL

IN ACCORDANCE WITH EIA-481

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# **REFLOW PROFILE**

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Reflow profile (Reference IPC/JEDEC J-STD-020)					
Temperature Min Preheat	T <sub>SMIN</sub>	150°C			
Temperature Max Preheat	T <sub>SMAX</sub>	200°C			
Time (T <sub>SMIN</sub> to T <sub>SMAX</sub> )	t <sub>S</sub>	60-180 sec.			
Temperature	TL	217°C			
Peak Temperature	$T_{P}$	260°C			
Ramp-up rate	R <sub>UP</sub>	3°C/sec max.			
Ramp-down rate	R <sub>DOWN</sub>	6°C/sec max.			
Time within 5°C of Peak Temperature	t <sub>P</sub>	10 sec.			
Time t[25°C] to Peak Temperature	t[25°C] to Peak	480 sec.			
Time	t,	60-150 sec			

# ENVIRONMENTAL

PARAMETER	VALUE
MOISTURE SENSITIVITY LEVEL	1
RoHS	6/6 COMPLIANT & LEAD FREE
REACH SVHC	COMPLIANT
HALOGEN-FREE	COMPLIANT
ESD CLASSIFICATION LEVEL	N/A
TERMINATION FINISH	Au
UNIT WEIGHT (GRAMS)	0.048



May 2016



**SERIES H130B** 

# Declaration of Conformity Recast Directive 2011/65/EU Certificate of Compliance

Reference: H130B family of SMD Crystal

**Raltron / RAMI Technology** hereby certifies that the part(s)/product(s) listed above are compliant with the Recast Directive 2011/65/EU for the Restriction of the use of certain Hazardous Substances in electrical equipment as passed on July 21<sup>st</sup>, 2011. Any trace impurities of the RoHS substances in the part(s)/product(s) listed above are below the Recast specified levels.

The following table lists the restricted materials and their respective allowable limits:

Recast Restricted Substance	Threshold Level (at homogenous material level)
Cadmium (Cd)	0.01% or 100ppm
Hexavalent Chromium (Cr+6)	0.1% or 1000ppm
Lead (Pb)	0.1% or 1000ppm
Mercury (Hg)	0.1% or 1000ppm
Polybrominated Biphenyl (PBB)	0.1% or 1000ppm
Polybrominated Diphenyl Ether (PBDE)	0.1% or 1000ppm

January 2016

Jahn D. Ixens

John D. Ivens Quality Assurance Director Raltron/RAMI Technology

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# **Certificate of REACH SVHC**

Revised 12/21/2015

**Date:** 21 December 2015 **Ref:** H130B family of Crystals

**Raltron / RAMI Technology** hereby certifies that its products, identified by the product family listed above; do not contain any of the REACH Substances of Very High Concern (SVHC) according to the Candidate list published by ECHA (European Chemical Agency) dated:

28 October 2008

13 January 2010

30 March 2010

18 June 2010

15 December 2010

20 June 2011

19 December 2011

18 June 2012

19 December 2012

20 June 2013

16 December 2013

16 June 2014

17 December 2014

15 June 2015

17 December 2015

Regards,

Frank Parra

Frank Parra

Quality Assurance Director

Raltron /RAMI Technology